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Thomas, W.; CORNING INCORPORATED, 59 LeRoy Street, Canton, NY 13617 (US). **MURRAY, Gregory, L.**; CORNING INCORPORATED, Canton, NY 13617 (US).

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(74) Agent: **MURPHY, Edward, F., III**; 404 West Lake Road, Hammondsport, NY 14840 (US).

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(71) Applicant: **CORNING INCORPORATED** [US/US]; 1 Riverfront Plaza, Corning, NY 14831 (US).

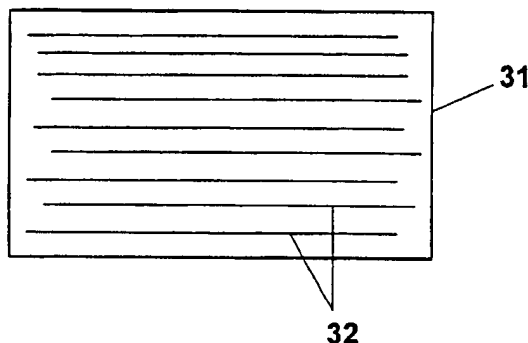
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(72) Inventors: **DAVIS, Claude, L., Jr.**; 3912 Meads Creek Road, Painted Post, NY 14870 (US). **BEST, Michael, E.**; CORNING INCORPORATED, Canton, NY 13617 (US). **EDWARDS, Mary, J.**; CORNING INCORPORATED, 8 Sunset Circle, Ogdensburg, NY 13669 (US). **HOBBS,**



(54) Title: A METHOD TO AVOID STRIAE IN EUV LITHOGRAPHY MIRRORS

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(57) **Abstract:** A method for manufacturing an EUV lithography element mirror includes sagging a plate of a glass material (41) to produce an EUV mirror blank (43) and polishing a top face of the EUV mirror blank (43) to produce a polished EUV mirror. A method for manufacturing an EUV lithography element mirror includes grinding a top face of a piece of a glass material (61); sagging a plate of the glass material over the top face of the piece (63) to produce an EUV mirror blank (66); and polishing a top face of the EUV mirror blank to produce an EUV polished mirror (65).

A METHOD TO AVOID STRIAE IN EUV LITHOGRAPHY MIRRORS

CROSS-REFERENCE TO RELATED APPLICATIONS

This application claims priority of provisional U.S. Application Serial No. 60/240,303, filed on October 13, 2000, and entitled "Method to Avoid Striae in EUV Mirrors."

FIELD OF THE INVENTION

[0001] The present invention relates to extreme ultraviolet (EUV) mirrors for EUV lithography. More particularly, it relates to methods for manufacturing EUV mirrors.

BACKGROUND OF THE INVENTION

[0002] Extreme ultraviolet (EUV) lithography (EUVL) is a relatively new form of lithography. EUVL uses extreme ultraviolet (EUV, also called soft X-ray) radiation with a wavelength in the range of 10 to 14 nanometers (nm) to perform the imaging. Up to now, optical lithography has been the lithographic technique of choice in the high-volume manufacture of integrated circuits (IC). The constant improvement in optical lithography has allowed it to remain the semiconductor industry's workhorse through the 100 nm or smaller generation of devices. However, to pack even higher density circuits into IC chips, new technologies (Next-Generation Lithographies, NGL) will be required. EUVL is one NGL technology vying to become the successor to optical lithography.

[0003] In many respects, EUVL is similar to the optical lithography. For example, as illustrated in FIG. 1, the basic optical design for an EUVL system is similar to that of an optical lithographic system. It comprises a light source **1**, a condenser **2**, a mask (reticle) **4** on a mask stage **5**, an optical system **6**, and a wafer **7** on a wafer stage **8**. Both EUV and optical lithographies use optical systems (cameras) to project images on the masks onto substrates which comprise silicon wafers coated with photo resists. However, the apparent similarity stops here. Because EUV is strongly absorbed by virtually all materials, EUV imaging must be performed in vacuum, which is achieved by enclosing the system in a chamber **3**. In addition, the chamber **3** might be further

partitioned into different compartments 10 and 20, which have their own vacuum systems. Because EUV is absorbed by most materials, there are no suitable lenses to focus and project an image on mask 4 onto a substrate (wafer) 7. As a result, it is necessary to operate EUVL in a reflective mode instead of a transmissive mode. In the reflective mode, light is reflected from mirrors (not shown; inside the optical system 6), instead of being transmitted through lenses. Even with reflective optics, there are not many materials capable of reflecting EUV. In order to achieve reasonable reflectivities at near normal incidence (i.e., an incident beam landing on the surface of a mirror at an angle close to normal to the surface), the surface of a mirror is typically coated with multilayer, thin-film coatings. These multilayer, thin-film coatings reflect EUV in a phenomenon known as distributed Bragg reflection.

[0004] The multilayer coatings for the reflective surfaces in EUVL imaging system consist of a large number of alternating layers of materials having dissimilar EUV optical constants. These multilayers provide a resonant reflectivity when the period of the layers is approximately $\lambda/2$, where λ is the wavelength. The most promising EUV multilayers are coatings of alternating layers of molybdenum (Mo) and silicon (Si). These layers are deposited with magnetron sputtering. Each layer of Mo or Si is coated to a thickness of $\lambda/4$ of the EUV light so that it will have a periodicity of $\lambda/2$. In this type of reflector, a small portion of the incident light is reflected from each silicon surface. The thickness of the layers causes the reflected light waves to interfere constructively. The more layers there are, the more light will be reflected. However, imperfections in the surface coating will eventually diminish the reflectivity return of more coatings. Currently, most mirrors in EUVL systems have around 40 alternating layer pairs of Mo:Si. Furthermore, most of these Mo:Si multilayers are optimized to function best with wavelengths at around 13.4 nm, which is the wavelength of a typical laser plasma light source.

[0005] A typical EUVL optical system or camera (see 6 in FIG. 1) consists of several mirrors (e.g., a four-mirror ring-field camera shown in FIG. 2). The mirrors that comprise the camera must have a very high degree of perfection in surface figure and surface finish in order to achieve diffraction limited imaging. It is predicted that the surface figure (basic shape) of each mirror must be accurate to 0.25 nm rms (root mean square) deviation, or better. In addition to surface figure, stringent requirement

must also be placed on the finish of the surfaces. The challenge for a fabricator of optics for EUVL is to achieve the desired levels of surface figure accuracy and surface finish simultaneously.

[0006] FIG. 2 illustrates a typical prior art four-mirror optical system for EUVL application. Such an optical system is used to project and reduce an image from a mask onto a wafer. The reduction achieved by the optical system permits the printing of a image smaller than that on the mask onto a wafer. The projection operation is typically carried out in a step-and-scan process. In a step-and-scan operation, a light beam from a light source (see 1 and 2 in FIG. 1) is used to scan the image on the mask. The light beam L reflected from the mask is further reflected by four mirrors M1, M2, M3 and M4 in succession to project and reduce the image from the mask onto the wafer.

[0007] The high degree of precision in figure and finish required for EUVL imaging requires that the mirrors should be substantially invariant to environmental changes, e.g., temperature changes. In order to afford better thermal management, it is preferred that these mirrors be made of light weight materials with very low coefficients of thermal expansion (CTE). One promising material for such application is a ultra low expansion glass material, such as the ULETM glass from Corning, Inc.

[0008] ULETM glass has a CTE of about 0 ± 30 ppb/ $^{\circ}\text{C}$ over the temperature range of 5 to 35 $^{\circ}\text{C}$. The CTE in ULETM glass is a function of the titanium concentration. ULETM glass typically contains about 6 to 8 wt. % of TiO_2 . Compositions containing about 7 wt. % TiO_2 have near zero CTE. In addition to having extremely low thermal expansion, ULETM glass is also unique in that it has no crystalline phase. In other words, ULETM glass is completely amorphous. ULETM glass is a high temperature glass which makes it unsuitable for manufacturing by conventional means. Instead of being poured, it is fabricated by a flame hydrolysis fused glass process which is similar in scope to chemical vapor deposition. In the flame hydrolysis process, high purity precursors of titanium oxide and silicon oxide are injected into flames to form deposit onto the surface of the growing glass. The process minimizes impurities such as sodium and other alkali or alkaline earth metals.

[0009] Due to its unique process of formation, ULE[™] glass is formed in layer deposits. This means ULE[™] glass inherently has striae, though these striae are not apparent and do not affect most applications. Although ULE[™] glass has been polished to 0.5 Å rms (root mean square) surface roughness, the striae may present problems for stringent applications like EUV mirrors. For example, it can create a mid frequency surface structure that would cause image degradation in mirrors used in the projection systems for EUV microlithography.

[0010] FIG. 3A illustrates a piece of ULE[™] glass 31, in which striae 32 are shown. When the striae are oriented perpendicular to the axis of a mirror and that mirror is subsequently ground and polished to a concave or convex shape, the striae planes are cut across. FIG. 3B shows a cylinder of ULE[™] glass 33 with its top ground to give a convex surface. It is apparent that different layers of striae planes are cut across, leaving approximately concentric circles of striae edges 34. This is not a problem for applications where the source light is in the range of visible to infrared. However, in EUV lithography, which uses lights with wavelengths around 13 nanometer (nm), these striae edges 34 may manifest themselves as small ridges. These can cause aberrations which would degrade any images projected within the optical train. Although this problem is illustrated with ULE[™] glass, the problem is not unique to this glass. The same problem due to striae will be encountered in any material that is prepared by gradual deposition of newly formed material onto the materials, like the flame hydrolysis process in the formation of ULE[™] glass. Such materials, which inherently have striae, will be generally referred to as the ULE[™] glass-like materials herein.

[0011] To make good use of the ULE[™] glass-like materials, it is desirable to have methods that can reduce the striae effect in the manufacturing of EUV mirrors of ultra low expansion materials.

SUMMARY OF INVENTION

[0012] Embodiments of the invention relate to methods for manufacturing mirrors for use in EUV lithography. Some embodiments include sagging a plate of a glass material to produce a mirror blank; and polishing a top face of the mirror blank to produce a polished mirror. Other embodiments include grinding a top face of a piece of a glass material; sagging a plate of the glass material over the top face of the piece

to produce a mirror blank; and polishing a top face of the mirror blank to produce a polished mirror. The glass material may be ultra low expansion glass material with a coefficient of thermal expansion of no more than 30 parts per billion per degree Celsius in a temperature range of 5 to 35 °C.

[0013] Other aspects and advantages of the invention will be apparent from the accompanying descriptions and drawings.

BRIEF DESCRIPTION OF DRAWINGS

- [0014] FIG. 1 is a diagram of a prior art EUVL system.
- [0015] FIG. 2 is a diagram illustrating a prior art four-mirror optic system for an EUVL camera.
- [0016] FIG. 3A is a diagram illustrating a piece of a ULE™ glass-like material having striae. FIG. 3B illustrates a cylindrical piece of a ULE™ glass-like material. The top of the cylinder has been ground to a convex configuration.
- [0017] FIG. 4A is a diagram illustrating a side view of a thin plate of a ULE™ glass-like material showing striae on the side. FIG. 4B shows the same side view after the thin plate was sagged to have a curved surface.
- [0018] FIG. 5A is a diagram illustrating a cylinder of a ULE™ glass-like material having striae planes perpendicular to the axis of the cylinder. FIG. 5B is a convex mirror blank prepared from the cylinder shown in FIG. 5A, showing the concentric striae ridges on the convex surface.
- [0019] FIG. 6A shows a top plate made of a ULE™ glass-like material about to be attached to a mirror base with a convex top face. FIG. 6B shows a mirror blank with the top plate annealed to the base.

DETAILED DESCRIPTION

- [0020] Embodiments of the invention relate to methods for manufacturing EUV mirrors from the ULE™ glass-like materials. The invention significantly reduces the striae effects which might degrade image qualities.

[0021] Some embodiments relate to methods of manufacturing thin-plate mirrors. FIG. 4A illustrates a side view of a thin plate 41, showing striae 42 on the side. The striae planes are parallel with the surfaces of the plate. If the surface of this plate were to be ground to the desired curvature, the grinding would cut across striae planes, and the above-mentioned problem will be unavoidable. According to one embodiment of the invention, as illustrated in FIG. 4B, instead, the thin plate 41 is "sagged" to the desired curved surface to produce a mirror blank 43, in which the striae planes 44 remain substantially parallel to the sagged, curved surface of the mirror. Because this sagged, curved surface has a near net shape of the final mirror, only minor polishing and grinding are required to produce a finished mirror. The problem associated with cutting across striae planes will be substantially eliminated. Sagging, as used herein, refers to the process of thermal deformation of a plate-like glass material. One skilled in the art would know that the exact conditions (temperature and duration) needed to achieve the desired degree of sagging will depend on the properties of the materials used. For ULE™ glass, a temperature of over 1300 °C, preferably 1450 – 1500 °C, is typically required.

[0022] The polishing or lapping of a finished mirror may be achieved by any method known in the art. When the mirror has been polished to the desired figure and finish, coating of molybdenum (Mo) and silicon (Si) can be accomplished with either magnetron sputtering, ion-beam sputtering, or other suitable methods. In a typical EUVL application, these mirrors should be coated with multiple alternating layers of Mo and Si. Polishing as used herein may include the Mo:Si coating step.

[0023] Other embodiments of the invention relate to methods of manufacturing thick mirrors. With thick mirrors, the above-described sagging method is not applicable. When a mirror is sagged over a form, the material flows. This makes it difficult to maintain enough material to have a desired thickness. This difficulty can be overcome by using a combination of sagging and grinding.

[0024] According to one embodiment of the invention, FIG. 5A illustrates a thick cylindrical plate/block 53 showing that striae planes 54 are perpendicular to the axis of the cylinder. In this embodiment, this cylindrical block 53 is first ground to provide a top face with a shape near the net shape of the mirror. This produces a mirror base 55, which has a top face with striae planes cut through showing

approximately concentric striae ridges 56. Once the mirror base is ground to a near net shape, a thin plate (see 61 in FIG. 6A) may be annealed (sagged) to this base.

[0025] As illustrated in FIG. 6A, a thin plate 61 with striae planes 62 parallel with the surfaces of the plate may be sagged over the base 63, which is like the one shown in FIG. 5B. The mirror base 63 has a top face with a near net shape and striae ridges 64 due to cut through of striae planes. When the thin plate 61 is sagged over the top face of the mirror base 63, it produces a mirror blank 65, which is ready to be polished. Mirror 65 has a top face devoid of striae ridges because this top face is the top face of the thin plate 61 as shown in FIG. 6A. Sagging of thin plate 61 over the mirror base results in the striae planes 67 to remain parallel with the curved top face 66. Thus, in mirror blank 65, all striae ridges are on the side, instead of the top face. Because this mirror 65 has a near net shape, only minor grinding and polishing are needed to produce the finished mirror. This will eliminate or minimize the cutting through of the striae planes and the problems associated with it.

[0026] Several methods known in the art are suitable for annealing the top plate 61 to the base 63. These include thermal fusion, frit fusion, and annealing using an adhesive (i.e., adhesion). With thermal fusion, the top plate 61 and the base 63 are fused (joined) by applying thermal energy to melt the regions at the joint. In frit fusion, low-melting frits (powders) of a glass material are added to the joint to "glue" the pieces together when heated. For example, U.S. Patent No. 6,048,811, which was assigned to the same assignee herein, discloses a frit fusion process suitable for this process. Similarly, the annealing may be achieved by adhesion, i.e., by applying suitable adhesive materials at the joint. Suitable adhesive materials include, but not limited to, epoxies, silicone adhesives, and solder or bonding materials which, upon heating, will melt and form a bond between the base and the faceplate. When the faceplate is constructed of a material having a CTE closely equivalent or identical to that of the base, the adhesive should ideally match the CTE.

[0027] While the invention has been described using a limited number of embodiments, those skilled in the art, having the benefit of this disclosure, will appreciate that other variations are possible without departing from the scope of the invention as disclosed herein. Accordingly, the scope of the invention should be limited only by the attached claims.

What is claimed is:

- [c1] A method for manufacturing an EUV lithography element, comprising:
- sagging a plate of a glass material to produce a blank; and
- polishing a top face of the blank to produce a finished lithography element.
- [c2] The method of claim 1, wherein the glass material is made by flame hydrolysis.
- [c3] The method of claim 1, wherein the glass material comprises an ultra low expansion glass material.
- [c4] The method of claim 3, wherein the ultra low expansion glass material has a coefficient of thermal expansion of no more than about 30 parts per billion per degree Celsius in a temperature range of 5 to 35 degrees Celsius.
- [c5] A method for manufacturing a EUV lithography element, comprising:
- grinding a top face of a piece of a glass material;
- sagging a plate of the glass material over the top face of the piece to produce a blank; and
- polishing a top face of the blank to produce a finished lithography element.
- [c6] The method of claim 5, wherein the glass material is made by flame hydrolysis.
- [c7] The method of claim 5, wherein the glass material comprises an ultra low expansion glass material.
- [c8] The method of claim 5, wherein the ultra low expansion glass material has a coefficient of thermal expansion of no more than about 30 parts per billion per degree Celcius in a temperature range of 5 to 35 degrees Celcius.
- [c9] A method for manufacturing a mirror, comprising:
- sagging a plate of a glass material to produce a mirror blank; and
- polishing a top face of the mirror blank to produce a finished mirror.

- [c10] The method of claim 9, wherein the glass material is made by flame hydrolysis.
- [c11] The method of claim 9, wherein the glass material comprises an ultra low expansion glass material.
- [c12] The method of claim 11, wherein the ultra low expansion glass material has a coefficient of thermal expansion of no more than about 30 parts per billion per degree Celsius in a temperature range of 5 to 35 degrees Celsius.
- [c13] A method for manufacturing a mirror, comprising:
- grinding a top face of a piece of a glass material;
 - sagging a plate of the glass material over the top face of the piece to produce a mirror blank; and
 - polishing a top face of the mirror blank to produce a finished mirror.
- [c14] The method of claim 13, wherein the glass material is made by flame hydrolysis.
- [c15] The method of claim 13, wherein the glass material comprises an ultra low expansion glass material.
- [c16] The method of claim 13, wherein the ultra low expansion glass material has a coefficient of thermal expansion of no more than about 30 parts per billion per degree Celcius in a temperature range of 5 to 35 degrees Celcius.

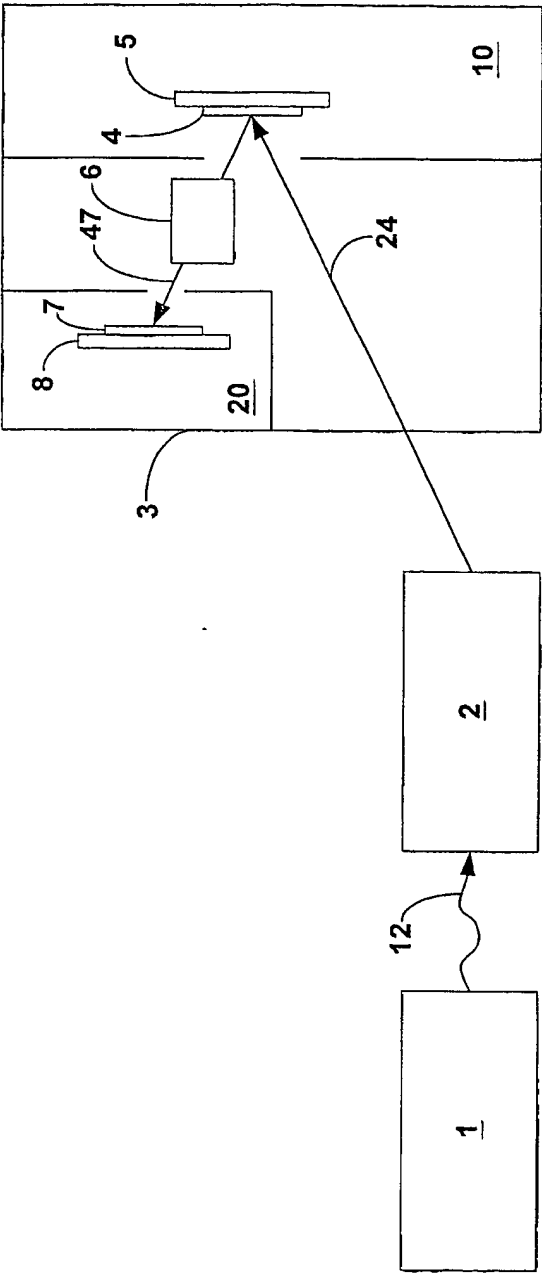


FIG. 1
(Prior Art)

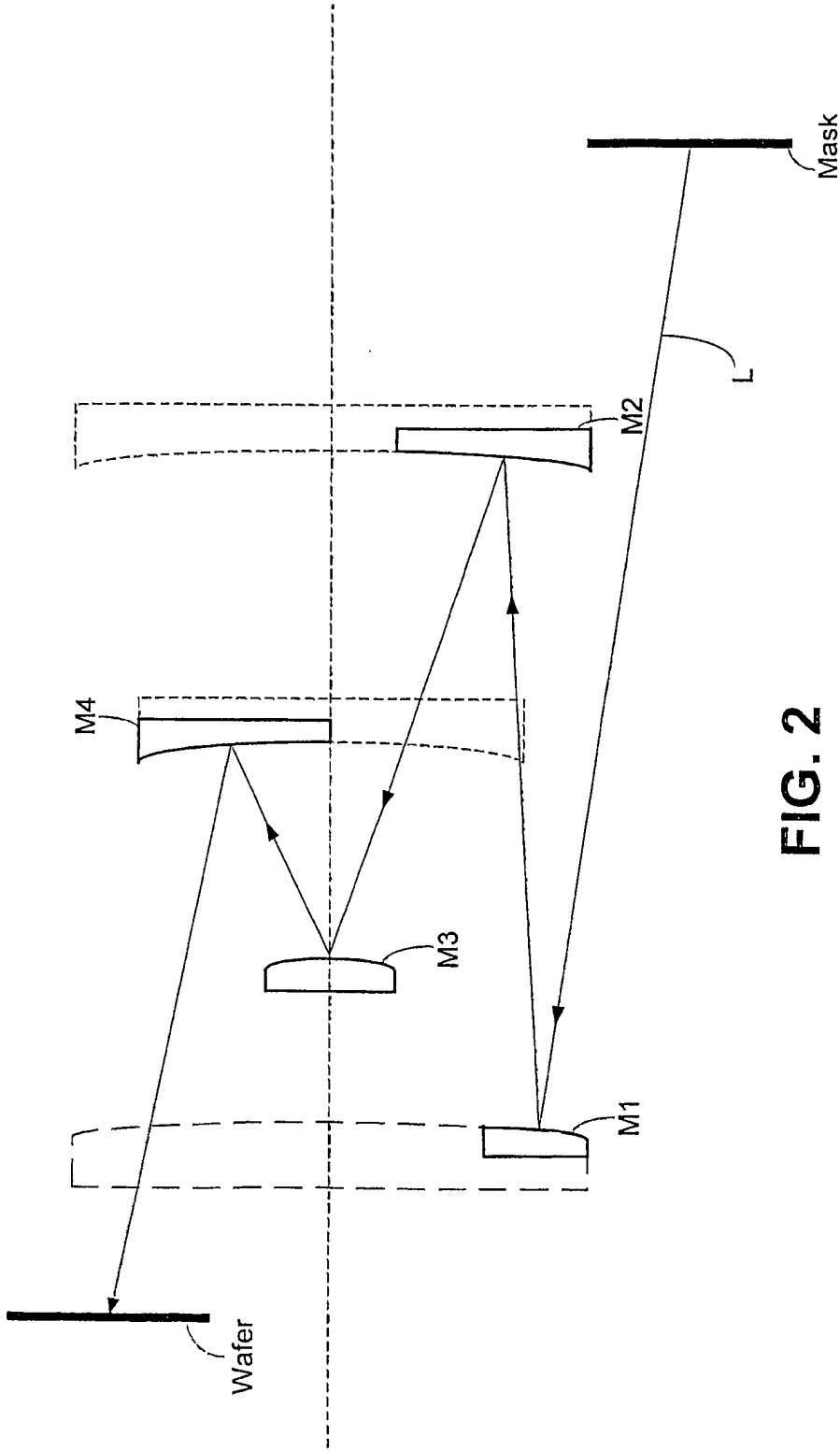
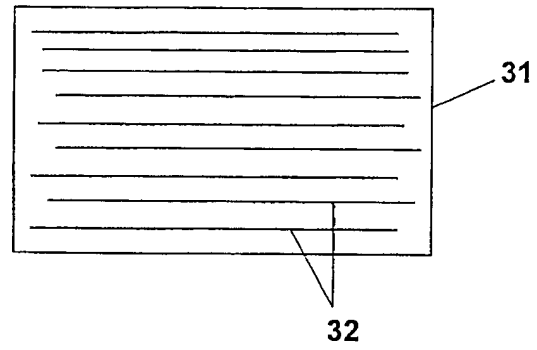
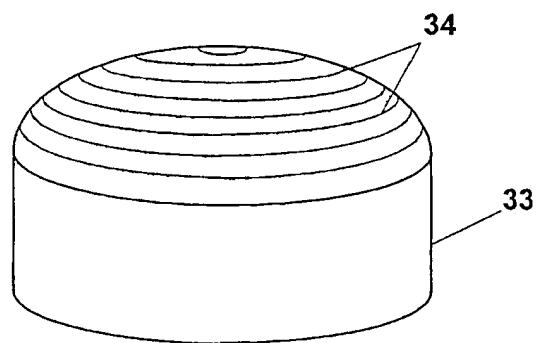


FIG. 2
(Prior Art)

FIG. 3A**FIG. 3B**

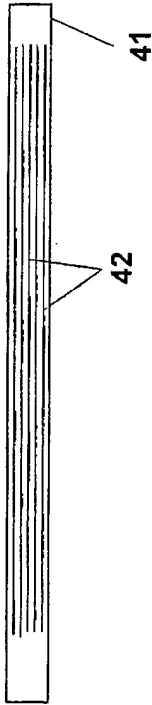


FIG. 4A



FIG. 4B

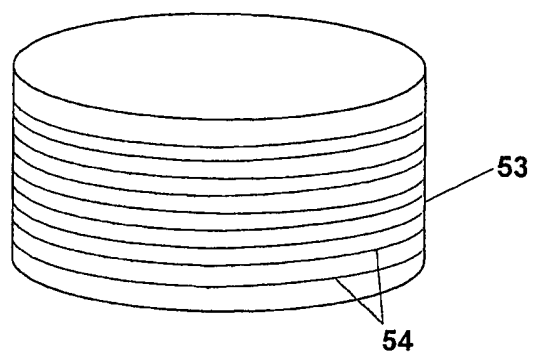
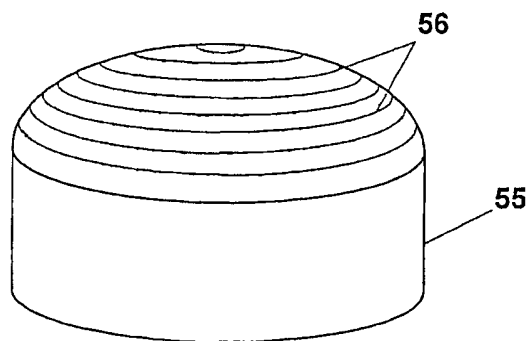
FIG. 5A**FIG. 5B**

FIG. 6A

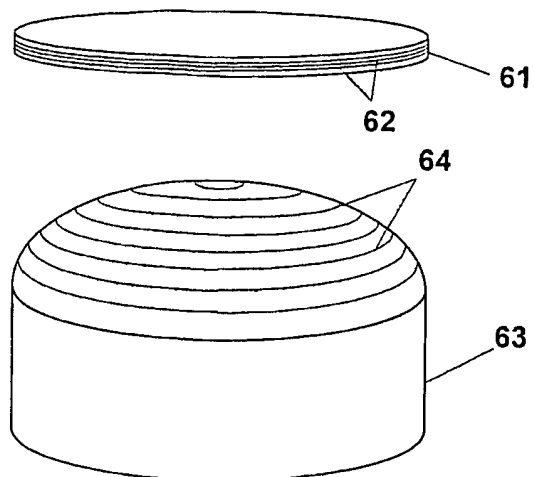
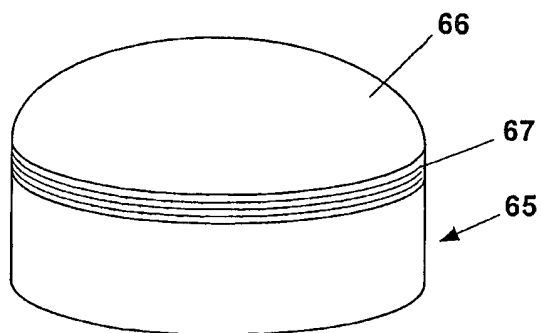


FIG. 6B



INTERNATIONAL SEARCH REPORT

International application No.
PCT/US01/29100

A. CLASSIFICATION OF SUBJECT MATTER

IPC(7) B24B 7/24

US CL 451/41

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

US 451/41

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)
search terms: EUV, lithography, sagging, polishing

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No
A	US 5,750,448 A (<i>GRABOWSKI et al.</i>) 12 May 1998, See the entire document.	1-16
A	US 4,282,021 A (<i>MAZEAU et al.</i>) 04 August 1981, See the entire document.	1-16
A	US 4,231,827 A (<i>WILSON et al.</i>) 04 November 1980, See the entire document.	1-16
A	US 4,130,437 A (<i>MAZEAU et al.</i>) 19 December 1978, See the entire document.	1-16
A	US 3,958,052 A (<i>GALUSHA et al.</i>) 18 May 1976, see the entire document.	1-16

☐ Further documents are listed in the continuation of Box C. ☐ See patent family annex

* Special categories of cited documents	**	Later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention
"A" document defining the general state of the art which is not considered to be of particular relevance	"X"	document of particular relevance, the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone
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Name and mailing address of the ISA/US
Commissioner of Patents and Trademarks
Box PCT
Washington, DC 20231

Facsimile No (703) 805-3230

Authorized officer

DAVID THOMAS

Telephone No (703) 805-3230

Shirley Verney
Patent Specialist
Technology Center 3700